MITSUBISHI MICROCOMPUTERS

M50747-XXXSP/FP

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

DESCRIPTION

The M50747-XXXSP is a single-chip microcomputer designed with CMOS silicon gate technology. It is housed in a 64-pin shrink plastic molded DIP (flat package type also available). This single-chip microcomputer is useful for business equipment and other consumer applications.

In addition to its simple instruction sets, the ROM, RAM, and I/O addresses are placed on the same memory map to enable easy programming.

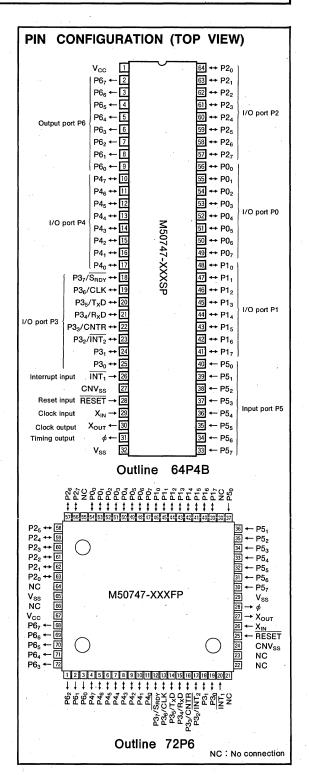
The differences between the M50747-XXXSP and the M50747-XXXFP are the package outline and power dissipation ability (absolute maximum ratings).

DISTINCTIVE FEATURES

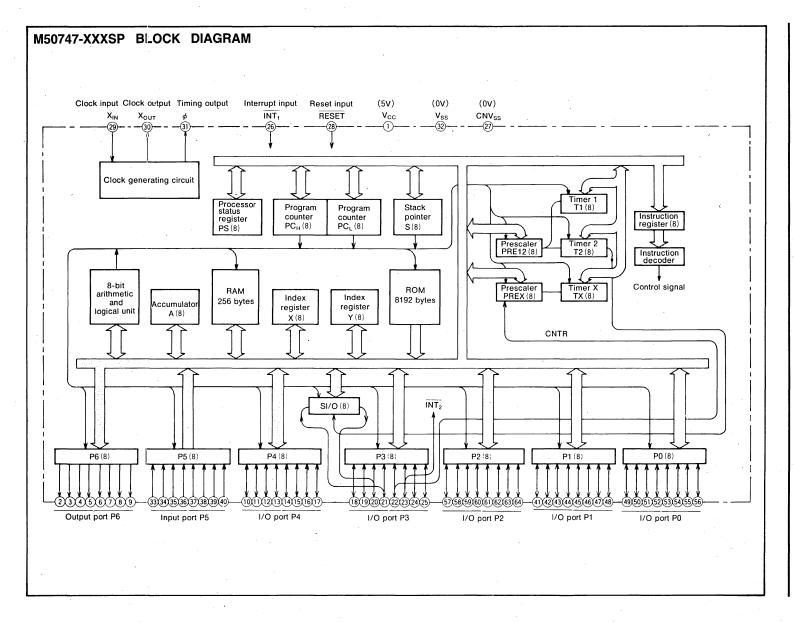
•	Number of basic instructions 69
•	Memory size ROM ······ 8192 bytes
	RAM 256 bytes
•	Instruction execution time
	······ 1μs (minimum instructions at 8MHz frequency)
•	Single power supply $f(X_{IN})=8MHz\cdots5V\pm10\%$
•	Power dissipation
	normal operation mode (at 8MHz frequency) ···· 30mW
•	Subroutine nesting ·······128 levels (max.)
•	Interrupt······7 types, 5 vecters
•	8-bit timer ·······3 (2 when used as serial I/O)
•	Programmable I/O (Ports P0, P1, P2, P3, P4) ········ 40
•	Input ports (Port P5)8
•	Output ports (Port P6)8
•	Serial I/O (Clock synchronized or UART)·············1

APPLICATION

Office automation equipment VCR, Tuner, Audio-visual equipment







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FUNCTIONS OF M50747-XXXSP

	Parameter		Functions		
Number of basic instructions	,	1	69		
Instruction execution time			1μs (minimum instructions, at 8MHz of frequency)		
Clock frequency	•		8MHz		
M	ROM		8192bytes		
Instruction execution time Clock frequency Memory size Input/Output port Serial I/O Timers Subroutine nesting Interrupts Clock generating circuit Supply voltage Power dissipation Input/Output characteristics	RAM		256bytes		
	ĪNT ₁	Input	1-bit×1		
	DO D4 D0 D0 D4	1/0	8-bit×5 (Part of P3 are in common with Input/output of serial I/O,		
Input/Output port	P0, P1, P2, P3, P4	1/0	timer I/O and INT ₂ interrupt input)		
	P5	Input	8-bit×1		
	P6	8-bit×1			
Serial I/O	8-bit or 9-bit×1				
Timers			8-bit prescalerX2+8-bit timerX3 (8-bit timerX2 when serial I/O is used)		
Subroutine nesting			128 levels (max.)		
I-1			Two external interrupts (1 of external interrupt is in common with port P3 ₂)		
interrupts			Three timer interrupts (or timerX2, serial I/OX1)		
Clock generating circuit			Built-in (Ceramic or Quartz crystal oscillator)		
Supply voltage			5V±10%		
Power dissipation	at high-speed operation		30mW (at 8MHz frenquency)		
Input/Output abarostoriation	Input/output voltage		5V		
input/Output characteristics	Output current		5mA (Ports P3, P4, P6)		
Memory expansion			Possible		
Operating temperature range			−10~70°C		
Device structure			CMOS silicon gate		
Package	M50747-XXXSP		64-pin shrink plastic molded DIP		
rackage	M50747-XXXFP		72-pin plastic molded QFP		

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PIN DESCRIPTION

Pin	Name	Input/ Output	Functions
V _{CC} V _{ss}	Supply voltage		Power supply inputs 5V \pm 10% to V _{CC} , and 0V to V _{SS} .
CNVss	CNV _{SS}	-	This is usually connected to V _{SS} .
RESET	Reset input	Input	To enter the reset state, the reset input pin must be kept at a "L" for more than 2\mus (under normal Vcc conditions). If more time is needed for the crystal oscillator to stabilize, this "L" condition should be maintained for the required time.
XIN	Clock input	Input	This chip has an internal clock generating circuit. To control generating frequency, an external ceramic or a quartz crystal oscillator is connected between the X_{IN} and X_{OUT} pins. If an external clock is used, the clock
Хоит	Clock output	Output	quartz crystal oscillator is connected between the X_{IN} and X_{OUT} pins. If an external clock is used, the clock source should be connected the X_{IN} pin and the X_{OUT} pin should be left open.
φ	Timing output	Output	This is the timing output pin.
CNTR	Timer I/O	1/0	This is an I/O pin for the timer X.
ĪNT ₁	Interrupt input	Input	This is the highest order interrupt input pin.
P0 ₀ ~P0 ₇	I/O port P0	1/0	Port P0 is an 8-bit I/O port with directional registers allowing each I/O bit to be individually programmed as input or output. At reset, this port is set to input mode. The output structure is CMOS output.
P1 ₀ ~P1 ₇	I/O port P1	1/0	Port P1 is an 8-bit I/O port and has basically the same functions as port P0.
P2 ₀ ~P2 ₇	I/O port P2	1/0	Port P2 is an 8-bit I/O port and has basically the same functions as port P0.
P3 ₀ ~P3 ₇	I/O port P3	1/0	Port P3 is an 8-bit I/O port and has basically the same functions as port P0. When serial I/O is used, P3 ₆ , P3 ₅ , and P3 ₄ work as CLK, T_XD pins, respectively. When clock synchronous serial I/O is used, P3 ₇ works as $\overline{S_{RDY}}$. Also P3 ₃ and P3 ₂ work as CNTR pin and the lowest order interrupt input pin ($\overline{INT_2}$), respectively.
P4 ₀ ~P4 ₇	I/O port P4	1/0	Port P4 is an 8-bit I/O port and has basically the same functions as port P0.
P5 ₀ ~P5 ₇	Input port P5	Input	Port P5 is an 8-bit input port.
P6 ₀ ~P6 ₇	Output port P6	Output	Port P6 is an 8-bit output port. The output structure is CMOS output.

BASIC FUNCTION BLOCKS

MEMORY

A memory map for the M50747-XXXSP is shown in Figure 1. Addresses $\rm E000_{16}$ to FFFF₁₆ are assigned to the built-in ROM area which consists of 8192 bytes.

Addresses $FF00_{16}$ to $FFFF_{16}$ are a special address area (special page). By using the special page addressing mode of the JSR instruction, subroutines addressed on this page can be called with only 2 bytes. Addresses $FFF4_{16}$ to $FFFF_{16}$ are vector addresses used for the reset and inter-

rupts (see interrupt chapter). Addresses 0000_{16} to $00FF_{16}$ are the zero page address area. By using the zero page addressing mode, this area can also be accessed with 2 bytes. The use of these addressing methods will greatly reduce the object size required. The RAM, I/O port, timer, etc., are assigned to this area.

Addresses 0000_{16} to $00BF_{16}$ and 0100_{16} to $013F_{16}$ are assigned to the built-in RAM and respectively consist of 192 bytes and 64 bytes of static RAM. In addition to data storage, this RAM is used for the stack during subroutine calls and interrupts.

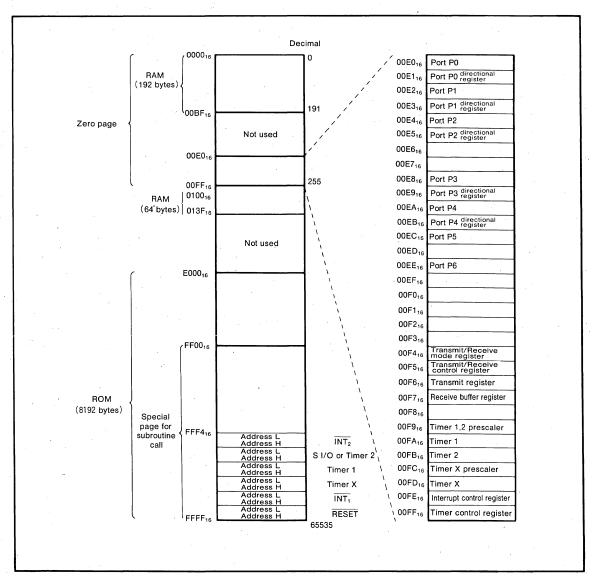


Fig.1 Memory map

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CENTRAL PROCESSING UNIT (CPU)

The CPU consists of 6 registers and is shown in Figure 2.

ACCUMULATOR (A)

The 8-bit accumulator (A) is the main register of the micro-computer. Data operations such as data transfer, Input/Out-put, etc., are executed mainly through accumulator.

INDEX REGISTER X (X)

The index register X is an 8-bit register.

In the index addressing mode, the value of the OPERAND added to the contents of the register X, specifies the real address. When the T flag in the processor status register is set to "1", the index register X itself becomes the address for the second OPERAND.

INDEX REGISTER Y (Y)

The index register Y is an 8-bit register.

In the index addressing mode, the value of the OPERAND added to the contents of the register Y specifies the real address.

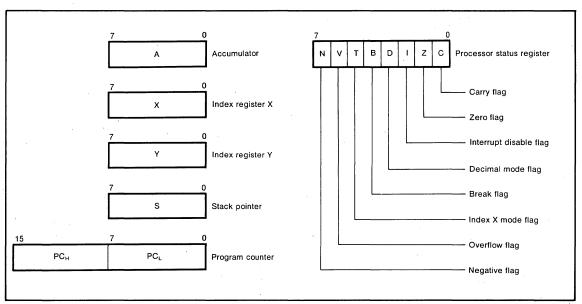


Fig.2 Register structure

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STACK POINTER (S)

The stack pointer (S) is an 8-bit register that contains the address of the next location in the stack. It is mainly used during interrupts and subroutine calls. The stack pointer is not automatically initialized after reset and should be initialized by the program using the TXS instruction.

The location of the stack can be determined by the stack page bit (bit 4 at address $00FF_{16}$). When bit 4 is "0" and the contents of the stack pointer is XX_{16} , the stack address is set to $00XX_{16}$. When bit 4 is "1", the stack address is set to $01XX_{16}$. When using this microcomputer in the single-chip mode, the stack page bit must be "0" and the stack pointer should be set at the bottom address of the internal RAM.

When an interrupt occurs, the higher 8 bits of the program counter are pushed into the stack first, and then the lower 8 bits of the program counter are pushed into the stack. After each byte is pushed into the stack, the stack pointer is decremented by one. Next, the contents of the processor status register are pushed into the stack. When the return from interrupt instruction (RTI) is executed, the program counter are processor status register data is pulled off the stack in reverse order from above.

The Accumulator is never pushed into the stack automatically. A Push Accumulator instruction (PHA) is provided to execute this function. Restoring the Accumulator to its previous value is accomplished by the Pull Accumulator instruction (PLA). It is executed in reverse order of the PHA instruction.

The contents of the Processor Status Register (PS) are pushed (pulled) to (from) the stack with the PHP and PLP instructions, respectively. Only the program counter is pushed into the stack during a subroutine call. Therefore, any registers that should not be destroyed should be pushed into the stack manually. The RTS instruction is used to return from a subroutine.

PROGRAM COUNTER (PC)

The 16-bit program counter consists of two 8-bit registers PC_H and PC_L . The program counter is used to indicate the address of the next instruction to be executed.

PROCESSOR STATUS REGISTER (PS)

The processor status register is composed entirely of flags used to indicate the condition of the processor immediately after an operation. Branch operations can be performed by testing the Carry flag (C), Zero flag (Z), Overflow flag (V) or the Negative flag (N). Each bit of the register is explained below.

1. Carry flag (C)

The carry flag contains the carry or borrow generated by the Arithmetic and Logical operation Unit (ALU) immediately after an operation. It also changed by the shift and rotate instructions. The set carry (SEC) and clear carry (CLC) instructions allow direct access for setting and clearing this flag.

2. Zero flag (Z)

This flag is used to indicate if the immediate operation generated a zero result or not. If the result is zero, the zero flag will be set to "1". If the result is not zero, the zero flag will be set to "0".

3. Interrupt disable flag (I)

This flag is used to disable all interrupts. This is accomplished by setting the flag to "1". When an interrupt, this flag is automatically set to "1" to prevent other interrupts from interfering until the current interrupt is completed. The SEI and CLI instructions are used to set and clear this flag, respectively.

4. Decimal mode flag (D).

The decimal mode flag is used to define whether addition and subtraction are executed in binary or decimal. If the decimal mode flag is set to "1", the operations are executed in decimal, if the flag is set to "0", the operations are executed in binary. Decimal correction is automatically executed. The SED and CLD instructions are used to set and clear this flag, respectively.

5. Break flag (B)

When the BRK instruction is executed, the same operations are performed as in an interrupt. The address of the interrupt vector of the BRK instruction is the same as that of the lowest priority interrupt. The contents of the B flag can be checked to determine which condition caused the interrupt. If the BRK instruction caused the interrupt, the break flag will be "1", otherwise it will be "0".

6. Index X mode flag (T)

When the T flag is "1", operations between memories are executed directly without passing through the accumulator. Operations between memories involving the accumulator are executed when the T flag is "0" (i.e., operation results between memories 1 and 2 are stored in the accumulator). The address of memory 1 is specified by the contents of the index register X, and that of memory 2 is specified by the normal addressing mode. The SET and CLT instructions are used to set and clear the index X mode flag, respectively.



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7. Overflow flag (V)

The overflow flag functions when one byte is added or subtracted as a signed binary number. When the result exceeds +127 or -128, the overflow flag is set to "1". When the BIT instruction is executed, bit 6 of the memory location is input to the overflow flag. The overflow flag is reset by the CLV instruction and there is no set instruction.

8. Negative flag (N)

The negative flag is set whenever the result of a data transfer or operation is negative (bit 7 is set to "1"). Whenever the BIT instruction is executed, bit 7 of the memory location is input to the negative flag. There are no instructions for directly setting or resetting the negative flag.

Table 1 Interrupt vector address and priority

Interrupt	Priority	Vector address
RESET	1	FFFF ₁₆ , FFFE ₁₆
ĪNT ₁	2	FFFD ₁₆ , FFFC ₁₆
Timer X	3	FFFB ₁₆ , FFFA ₁₆
Timer 1	4	FFF9 ₁₆ , FFF8 ₁₆
Timer 2 or serial I/O	5	FFF7 ₁₆ , FFF6 ₁₆
INT ₂ (BRK)	6	FFF5 ₁₆ , FFF4 ₁₆

INTERRUPT

The M50747-XXXSP can be interrupted from seven souces; $\overline{INT_1}$, timer X, timer 1, timer 2/serial I/O, or $\overline{INT_2}/BRK$ instruction.

However, the $\overline{\text{INT}_2}$ pin is used with port P3₂ and the corresponding directional register bit should be set to "0" when P3₂ is used as an interrupt input pin.

The value of bit 2 and bit 3 of the transmit/receive mode register (address 00F4₁₆) determine whether the interrupt is from timer 2 or from serial I/O. When these bits are "00" the interrupt is from timer 2, otherwise the interrupt is from serial I/O. Also, when the bit 2 is "1", parts of port P3 are used for serial I/O. These interrupts are vectored and their priorities are shown in Table 1. Reset is included in this table since it has the same functions as the interrupts.

When an interrupt is accepted, the contents of certain registers are pushed into specified locations, (as discussed in the stack pointer section) the interrupt disable flag I is set, the program jumps to the address specified by the interrupt vector, and the interrupt request bit is cleared automatically. The reset interrupt is the highest priority interrupt and can never be inhibited. Except for the reset interrupt, all interrupts are inhibited when the interrupt disable flag is set to "1". All of the other interrupts can further be controlled individually via the interrupt control register shown in Figure

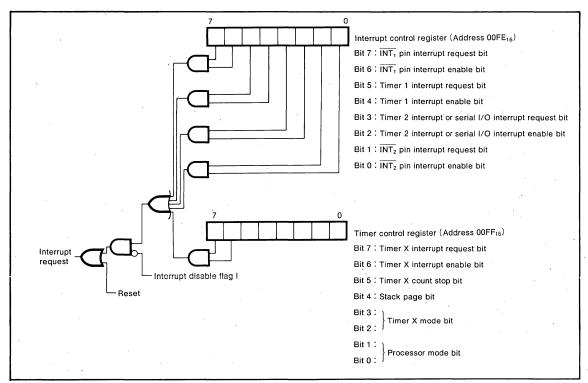


Fig.3 Interrupt control

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3. An interrupt is accepted when the interrupt enable bit and the interrupt request bit are both "1" and the interrupt disable flag is "0".

The interrupt request bits are set when the following conditions occur:

- (1) When the $\overline{INT_1}$ or $\overline{INT_2}$ pins go from "H" to "L"
- (2) When the contents of timer X, timer 1, timer 2 (or the serial I/O counter) go to "0" $\,$

These request bits can be reset by the program but can not be set by the program. However, the interrupt enable bit can be set and reset by the program.

The interrupt from serial I/O is used switching with that from timer 2. This interrupt is slightly different from the others. When serial I/O is selected, the interrupt becomes automatically the interrupt from serial I/O. Because the interrupt request bit of timer 2 is edge-senced and not level-

senced, when interrupts are generated from both transmit and receive sides as illustrated in Figure 5, transmit interrupts will not be accepted by only taking OR of receive interrupt flag RI and transmit flag TI. Even if RI is cleared to "0" by executing receive interrupt processing and is returned to the main routine, TI is "1" and its level will not be changed. In order to accept interrupts in the above state, when RI or TI is cleared from "1" to "0" the pulse is generated automatically and lets the request bit go from "H" to "L". By doing so, the level will be changed. The interrupt processing routine of serial I/O is shown in Figure 4.

Since the BRK instruction and the $\overline{\text{INT}_2}$ interrupt have the same vectored address, the contents of the B flag must be checked to determine if the BRK instruction caused the interrupt or if $\overline{\text{INT}_2}$ generated the interrupt.

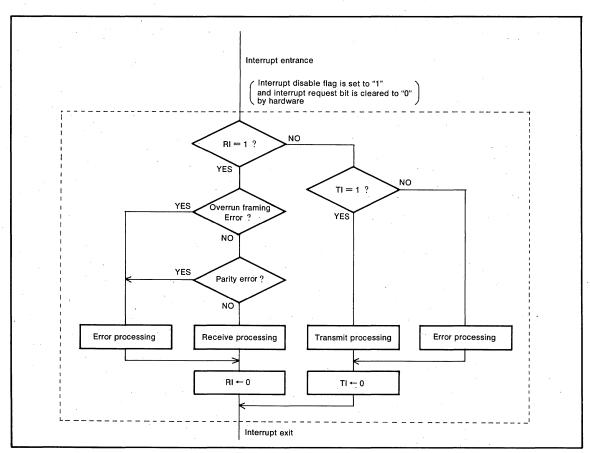


Fig.4 Interrupt processing routine

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TIMER

The M50747-XXXSP has three timers; timer X, timer 1, and timer 2. Since P3 (in serial I/O mode) and timer 2 use some of the same architecture, they cannot be used at the same time (see serial I/O section). Timer X has four modes which can be selected by bit 2 and 3 of the timer control register. When the timer X count stop bit (bit 5) is set to "1", the timer X will stop regardless of which mode it is in. A block diagram of timer X, timer 1, timer 2 and serial I/O is shown in Figure 5.

The $P3_3/CNTR$ pin cannot be used as CNTR when $P3_3$ is being used in the normal I/O mode.

Timer 1 and timer 2 share with a prescaler. This prescaler has an 8-bit programmable latch used as a frequency divider. The division ratio is defined as 1/(n+1), where n is the decimal contents of the prescaler latch. All three timers are down-count timers which are reloaded from the timer

latch following the zero cycle of the timer (i.e. the cycle after the timer counts to zero).

The timer interrupt request bit is set to "1" during the next clock pulse after the timer reaches zero. The interrupt and timer control registers are located at addresses $00FE_{16}$ and $00FF_{16}$, respectively (see interrupt section).

The four modes of timer X as follows:

- (1) .Timer mode (00)
 - In this mode the clock is driven by the oscillator frequency divided by 16. When the timer down-counts to zero, the timer interrupt request bit is set to "1" and the contents of the timer's latch is reloaded into the timer and the counting begins again.
- (2) Pulse output mode [01] In this mode, the polarity of the CNTR signal is reversed each time the timer down-counts to zero.

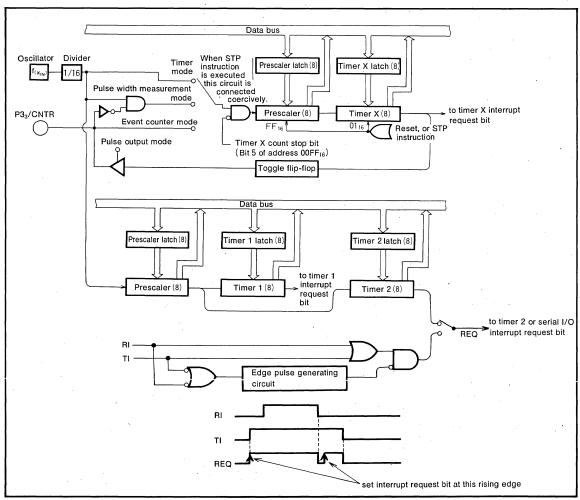


Fig.5 Interrupt block diagram of timer X, timer 1, timer 2 and serial I/O

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(3) Event counter mode (10)

This mode operates in the same manner as the timer mode except the clock source is input to the CNTR pin. This mode will allow an interrupt to be generated whenever a specified number of external events have been generated. The timer down-counts every rising edge of the clock source.

(4) Pulse width measurement mode [11]

This mode measures the pulse width (between lows) input to the CNTR pin. The timer, driven by the oscillator frequency divided by 16, continues counting during the low cycle of the CNTR pin. When the timer contents reaches "0", the interrupt request bit is set to "1", the timer's reload latch is reloaded and the counting resumes.

The structure of the timer control register is shown in Figure 6.

When the STP instruction is executed, or after reset, the prescaler and timer latch are set to FF₁₆ and 01₁₆, respectively. Also, when the STP instruction is executed, the oscillator's frequency (divided by 16) will become the counting source, regardless of the timer X mode setting. This state will be released when the timer X interrupt request bit is set to "1", or after a reset. Timer X will then enter the mode specified by its mode bits. For more details on the STP instruction, refer to the oscillation circuit section.

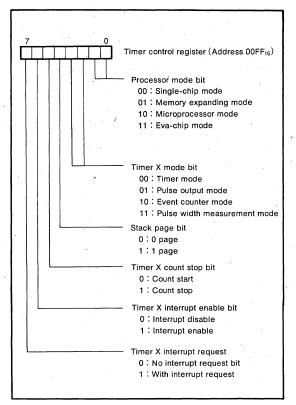


Fig.6 Structure of timer control register

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SERIAL I/O

Figure 7 is a block diagram of the serial I/O. Two types exist in serial data transfer: the clock synchronous type in which data is transferred, synchronized with the clock, and the asynchronous type (UART) in which data is transferred using the start and stop bits. The user can choose either type. There are two asynchronous type modes: 8-bit data transfer and 9-bit data transfer. The receive ready signal $(\overline{S_{RDY}})$, clock I/O (CLK), data I/O (T_XD and R_XD) pins share the same pins as P3₇, P3₆, P3₅, P3₄.

Figure 8 gives the bit configuration for the transmisson/receive mode register and transmisson/receive control register. The transmit/receive mode register (00F4 $_{16}$) is a 5-bit register. Bits 1 and 0 are used to define the clock source for synchronization. When the contents of bits 1 and 0 are [00] or [01], respectively, the external clock is used. The external clock is input to pin P3 $_{6}$. Use an external clock with a 50% duty cycle and a frequency lower than 500kHz. When the contents of bits 1 and 0 are [10] or [11], respectively, the built-in clock is used.

When the contents are [10], the overflow signal from timer 2 is used for the clock source. Therefore, by changing the division rate, the data transfer speed can be controlled.

When the contents are (11), the frequency obtained by dividing the oscillation frequency by 16 is used as the clock source.

Bits 2 and 3 are used to define which pins on port P3 are to be used as serial I/O, and which type of serial I/O to used. When the contents are [00], respectively, port P3 is used as a normal parallel port.

When the contents are [01], respectively, the clock synchronous type serial I/O is used.

 $P3_7/\overline{S_{RDY}}$ on port P3 is used as the receive ready signal pin. $P3_6/CLK$ is used as the input or output pin. When an external clock is to be used, the signal from the clock is connected to this pin. When the built-in clock is to be used, the signal from the clock is output to this pin. $P3_6/T_XD$ is used as the serial data output pin. $P3_4/R_XD$ is used as the serial data input pin. When this pin is not used as the serial data input pin, it can be used as the normal input/output pin. When this pin is used as the serial data input pin, set the directional register to the input mode.

When the contents are [10], this serial I/O is used as an 8-bit asynchronous serial I/O. If the external clock source is selected together with the bit contents [10], the clock signal is input to P3 $_6$ /CLK on port P3. The data transfer speed is 1/16 of the clock frequency. When the built-in clock is used, this can be used as the normal input/output pin. P3 $_6$ / T $_X$ D is used as the serial data output pin. P3 $_4$ /R $_X$ D is used as the serial data input pin. When this is not used as the serial data input pin, it can be used as a normal input/output pin. When this pin is used as a serial data input pin, set the directional register to the input mode. When the contents are [11], a 9-bit asynchronous serial I/O is selected. The functions on port P3 are the same as in the 8-bit case. Bit 4 is used to select the sleep mode. The sleep mode is

valid only for asynchronous transmission. See the section on the sleep mode for further explanation. When the contents are "0", the sleep mode is disabled. When the contents are "1", the sleep mode is enabled.

The transmission/receive control register is an 8-bit register. Bits 1, 3, 4, 5 and 7 are for read only. Each bit is explained as follows.

Transmit enable bit (TE)

When this bit is set to "0", the send clock is pulled up to "H", the transmit completion bit (TI) is cleared to "0", transmission is terminated, and the serial I/O is initialized. When this bit is set to "1", transmission starts. Therefore, send data must be written into the transmission register prior to setting it to "1". When the transmission is completed, the serial I/O stops and the transmission clock is pulled up to "H" automatically.

Once the above operation has been performed, transmission starts by writing data into the transmission register.

Transmit completion bit (TI)

This bit is cleared to "0" when the transmit enable bit (TE) is set to "0", or when data is written into the transmission register. When transmission is completed, this bit is set to "1". An OR operation is performed between the transmit completion bit (TI) and the receive completion bit (RI), and the result is input into the interrupt request bit (bit 3 of address 00FE₁₆). See the section on interrupts for more information.

Receive enable bit (RE)

When this bit is cleared to "0", the receive completion bit (RI), the overrun framing error (OFR), and the receive parity error bit (PER) are cleared and initialized. When this bit is set to "1", the I/O enters the receive enable status. For the clock synchronous type serial I/O, data is fetched from the $P3_4/R_XD$ pin and the contents of the receive register are shifted by 1 bit every time the receive clock changes from "L" to "H". For the asynchronous type I/O, receiving starts when a start bit is forwarded to $P3_4/R_XD$.

Receive completion bit (RI)

This bit is cleared to "0" when the receive enable bit is set to "0", or when writing is performed to the receive buffer register. If the receive buffer is written to, no data is written in the register and the previous data is preserved. When a set of data arrives in the receive buffer, and the receive completion bit (RI) is "0", data is transferred to the receive buffer register. With this operation, receiving terminates and the receive completion bit (RI) is set to "1". An OR operation is performed between the receive completion bit (RI), the transmit completion bit (TI), and the result is input to the interrupt request bit (bit 3 at address 00FE₁₆). For more information on the interrupts, see the corresponding section.



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Overrun framing error bit (OFR)

When the receive enable bit (RE) is set to "0" or when writing is performed to the receive buffer register, this bit is cleared to "0". If an overrun or framing error occurs, this bit is set to "1". An overrun error occurs when the receive completion bit (RI) remains set to "1" and the next data is transferred from the receive register to the receive buffer register. A framing error occurs when data arrives in the receive register, (which should be transferred to the receive buffer register), and no stop bit exists. This bit is valid only for asynchronous transmission.

Receive parity error bit (PER)

When the number of "1"s is in the received data register is odd, this bit is set to "1". This bit is cleared to "0" when the receive enable bit (RE) is set to "0" or when writing is performed to the receive buffer register.

Receive data bit (T8)

For 9-bit asynchronous transmission, this bit is transmitted as bit 8 data.

Receive data bit 8 (R8)

For 9-bit asynchronous transmission, this bit is used to receive the bit 8 data.

The operation of each transmission method is described below

CLOCK SYNCHRONOUS TYPE SERIAL TRANSMISSION

Receiving starts when the receive enable bit (RE) is set to "1". Every time the receive clock changes from "L" to "H", data is fetched from P3 $_4$ /R $_X$ D pin and, simultaneously, the contents of the receive register are shifted by 1 bit. Data transmission starts from the least significant bit. When 8 bits of data are received, the receive completion bit (RI) is set to "1". When RI changes from "0" to "1", the interrupt request bit is set to "1". When the internal clock is used, the receive clock stops in the "H" condition. When the external clock is used, the clock does not stop. In this case, control this clock using external devices. Once the receive enable bit (RE) is set to "1", writing to the receive buffer register clears the receive completion bit (RI) and receiving restarts. Set a "0" in the transmission enable bit during receiving.

Setting "1" in the transmission enable bit (TE) starts the transmission. Accordingly, write data in the transmission register before setting TE to "1". Every time the transmission clock changes from "H" to "L", data is output from the P3₅/T_xD pin. Data transmission starts from the least significant bit. The transmission completion bit (TI) is set to "1" for each 8 bits of data transmitted. When TI changes from "0" to "1", the interrupt request bit is set to "1". When the

internal clock is used, the clock stops in the "H" position after transmitting 8 bits of data. When an external clock is used, the clock does not stop. In this case, control this clock using external devices. Once the transmission enable bit is set to "1", writing data to the transmission register clears the transmission completion bit to "0" and starts the transmission. Set a "0" in the receive enable bit during transmission. When the external clock is used, the transmission speed is the same as that of the clock. When the internal clock is used, the clock frequency obtained by dividing the clock source by 16 is used for the transmission speed. Figure 9 gives the transmission timing. This figure also gives the timings for 8-bit and 9-bit asynchronous transmission, which is explained below.

8-BIT ASYNCHRONOUS TRANSMISSION

Setting the receive enable bit (RE) to "1" brings the I/O into the receiving ready status. Transmission starts when the first data that changes the level from "H" to "L" is received, and data is forwarded to the receive register. When 8 bits of data are received and the receive completion bit (RI) is set to "1", the 8-bits of data are transferred to the receive buffer register, and RI is set to "1". See the section on the interrupts for more information. If RI is set to "1", no transfer is performed. The overrun framing error bit (OFR) is set to "1" when RI is set to "1" and the next data is received. When the stop bit is set to "0", the OFR bit is set to "1" regardless of the RI bit status. No other condition will change the contents of this bit. When the number of "1"s in the received data register is odd, the receive error bit (PER) is set to "1". No other condition will change the contents of this bit. Bits RI, OFR, and PER are cleared to "0" when writing is performed to the receive buffer register. When 8-bits of data are received, receiving automatically halts and the start bit of the next data is ready.

When the transmission enable bit (TE) is set to "1" (after writing data to the transmit register), transmission starts. First, the start bit "0" is sent, and data is transferred starting from the least significant bit. When the stop bit "1" is sent, the transmission completion bit (TI) is set to "1" and the transmission terminates. For more information on the interrupt, see the corresponding section. After the above operation has been performed, the transmission completion bit (TI) is cleared to "0" and transmission restarts after writing to the transmit register is performed.

9-BIT ASYNCHRONOUS TRANSMISSION

Operation for 9-bit asynchronous transmission is same as 8-bit asynchronous transmission except that the transmission data consists of 9 bits. When receiving data, bit 8 of the received data is input to bit 7 on address 00F5₁₆ (transmit/receive control register). When transmitting data, the contents of bit 6 in the transmit/receive control register is output as bit 8 of the send data.

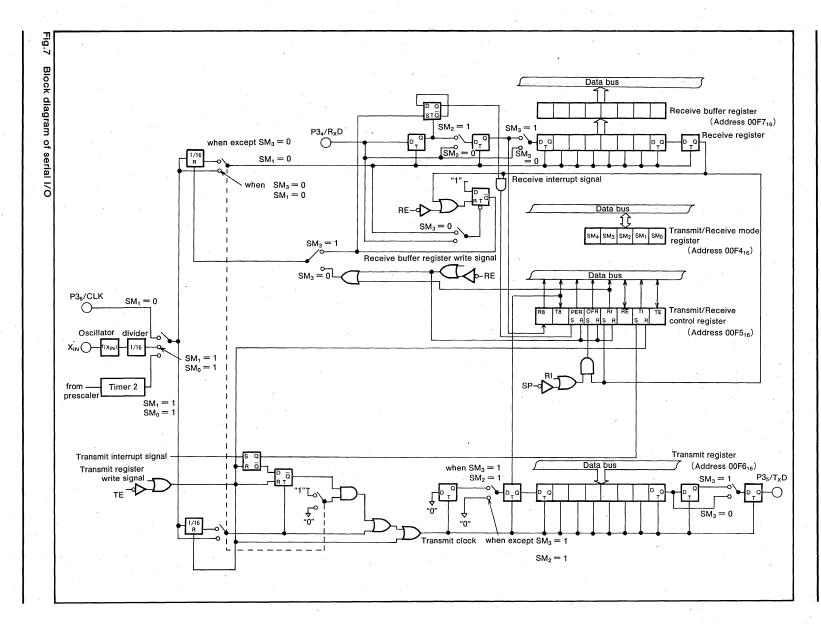


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

SLEEP MODE

For 9-bit asynchronous transmission, when bit 4 (SM_4) of the transmit/receive mode register (00F416) is set to "1" and bit 8 of the receive data is "0", the received data is ignored. When bit 8 of the receive data is set to "1", data is received. When the contents of SM4 is "0", data is received, regardless of the contents of bit 8 of the received data. For 8-bit asynchronous transmission, the stop bit works as bit 8 of the received data. The sleep mode is used when several local microcomputers are to be connected to a single host computer through the serial I/O. First, the host computer sets T8 to "1" and sends data. The data contains the address of the local microcomputer to be accessed. All the local microcomputers receive the same data. Each local microcomputer checks the data (address), and if the address is that assigned to the local microcomputer, bit 4 of the transmit/receive mode register is set to "0". Bit 4 of the registers of all the other local microcomputers is set to "1". Then, the host computer starts transmission by setting T8 to "0". The local microcomputer whose SM₄ is "0" receives the transmitted data, while the other local microcomputers continue program execution without being interrupted by serial I/O. This is because SM₄ on these computers set to "1". Thus, the host computer can communicate with a specific microcomputer.





M50747-XXXSP/FP

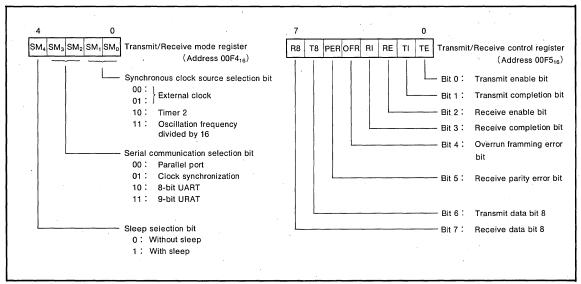
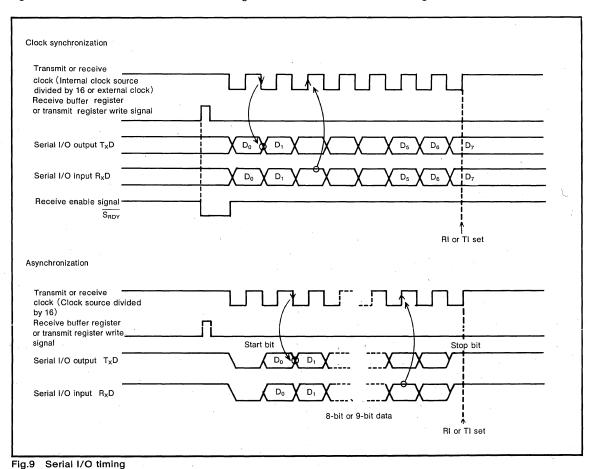


Fig.8 Bit structure of transmit/receive mode register and transmit/receive control register



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RESET CIRCUIT

The M50747-XXXSP is reset according to the sequence shown in Figure 10. It starts the program from the address formed by using the content of address FFFF₁₆ as the high order address and the content of the address FFFF₁₆ as the low order address, when the RESET pin is held at "L" level for more than $2\mu s$ while the power voltage is in the recommended operating condition and the crystal oscillator oscillation is stable and then returned to "H" level. The internal initializations following reset are shown in Figure 11. An example of the reset circuit is shown in Figure 12. When the power on reset is used, the RESET pin must be held "L" until the oscillation of X_{IN}-X_{OUT} becomes stable.

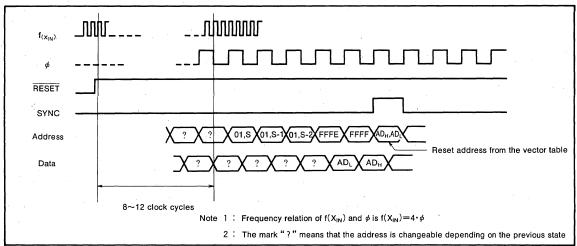
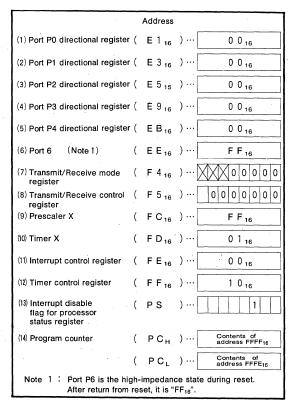


Fig.10 Timing diagram at reset



Power on M50747-XXXSP RESET 0.60 M50747-XXXSP RESET Supply voltage

Fig.12 Example of reset circuit

Fig.11 Internal state of microcomputer at reset

I/O PORTS

(1) Port P0

Port P0 is an 8-bit I/O port with CMOS output.

As shown in the memory map (Figure 1), port P0 can be accessed at zero page memory address $00E0_{16}$. Port P0 has a directional register (address $00E1_{16}$) which can be used to program each individual bit as input ("0") or as output ("1"). If the pins are programmed as output, the output data is latched to the port register and then output. When data is read from the output port the output pin level is not read, only the latched data in the port register is read. This allows a previously output value to be read correctly even though the output voltage level is shifted up or down. Pins set as input are in the floating state and the signal levels can thus be read. When data is written into the input port, the data is latched only to the port latch and the pin still remains in the floating state.

Depending on the contents of the processor status register (bit 0 and bit 1 at address 00FF₁₆), four different modes can be selected; single-chip mode, memory expanding mode, microprocessor mode and eva-chip mode. These modes (excluding single-chip mode) have a multiplexed address output function in addition to the I/O function. For more details, see the processor mode information.

(2) Port P1

In the single-chip mode, port P1 has the same function as P0. In the other modes, P1's functions are slightly different from P0's. For more details, see the processor mode information.

(3) Port P2

In the single-chip mode, port P2 has the same function as P0. In the other modes, P2's functions are slightly different from P0's.

For more details, see the processor mode information.

(4) Port P3

In the single-chip mode, port P3 has the same function as P0. In the other modes, P3's functions are slightly different from P0's. Port P3 can also be used as serial I/O, $\overline{\text{INT}_2}$ and I/O pins for timer X. For more details, see the processor mode information.

(5) Port P4

Port P4 has the same function as port P0 in the singlechip mode. This function does not change even though the processor mode changes.

(6) Port P5

Port P5 is an input.

(7) Port P6

Port P6 is a CMOS output port. See Figure 13 for more details.

(8) Clock φ output pin

In normal conditions, the oscillator frequency divided by four is output as ϕ .

(9) $\overline{INT_1}$ pin.

The $\overline{\text{INT}_1}$ pin is an interrupt input pin. The $\overline{\text{INT}_1}$ interrupt request bit (bit 7 at address 00FE_{16}) is set to "1" when the input level of this pin changes from "H" to "L".

(10) $\overline{INT_2}$ pin (P3₂/ $\overline{INT_2}$ pin)

The $\overline{INT_2}$ pin is an interrupt input pin used with P3₂. To use this pin as an interrupt pin, set the corresponding bit in the directional register to input ("0"). When this signal level changes from "H" to "L", the interrupt request bit (bit 1 at address $00FE_{16}$) is set to "1".

(11) CNTR pin (P3₃/CNTR pin)

The $P3_3/CNTR$ pin is an I/O pin of timer X. To use this pin as the timer X input pin, set the corresponding directional register bit to input ("0"). In the event counter mode, CNTR becomes the input pin of the external pulse. In the pulse output mode, the CNTR output changes polarity each time the contents of timer X goes to "0". In the pulse width measurement mode, the pulse to be measured is input to this pin.

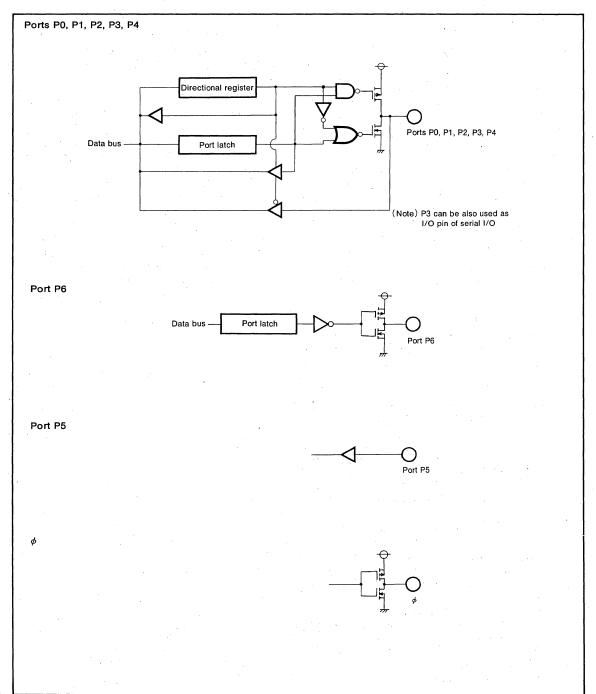


Fig.13 Block diagram of ports P0 \sim P6 (single-chip mode), and ϕ output format

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

PROCESSOR MODE

By changing the contents of the processor mode bit (bit 0 and 1 at address $00FF_{16}$), four different operation modes can be selected; single-chip mode, memory expanding mode, microprocessor mode and evaluation chip (evachip) mode. In the memory expanding mode, microprocessor mode and eva-chip mode, ports $P0 \sim P3$ can be used as multiplexed I/O for address, data and control signals, as well as the normal functions of the I/O ports.

Figure 15 shows the functions of ports $P0 \sim P3$.

The memory map for the single-chip mode is illustrated in Figure 1 and for other modes, in Figure 14.

By connecting CNV_{SS} to V_{SS} , all four modes can be selected through software by changing the processor mode bits. Connecting CNV_{SS} to V_{CC} automatically forces the microcomputer into microprocessor mode. Supplying 10V to CNV_{SS} places the microcomputer in the eva-chip mode. The four different modes are explained as follows:

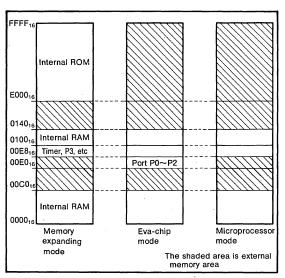


Fig.14 External memory area in processor mode

(1) Single-chip mode (00)

The microcomputer will automatically be in the single-chip mode when started from reset, if CNV_{SS} is connected to $\text{V}_{SS}.$ Ports P0 \sim P3 will work as original I/O ports.

(2) Memory expanding mode (01)

The microcomputer will be placed in the memory expanding mode when CNV_{SS} is connected to V_{SS} and the processor mode bits are set to "01". This mode is used to add external memory when the internal memory is not sufficient.

In this mode, port P0 and port P1 are as a system address bus and the original I/O pin function is lost.

Port P2 becomes the data bus of $D_7{\sim}D_0$ (including instruction code) and loses its normal I/O functions. Pins P3₁ and P3₀ output the SYNC and R/ \overline{W} control signals, respectively when ϕ enters into the "H" state. Port P3₂ functions as an input port during this same transition.

(3) Microprocessor mode (10)

After connecting CNV_{SS} to V_{CC} and initiating a reset, the microcomputer will automatically default to this mode.

In this mode, port P0 and P1 are used as the system address bus and the original function of the I/O pins is lost. Port P2 becomes the data bus $(D_7 \sim D_0)$ and loses its normal I/O functions. Port P3₁ and P3₀ become the SYNC and R/\overline{W} pins, respectively and the normal I/O functions are lost.

(4) Eva-chip mode [11]

When 10V is supplied to CNV_{SS} pin, the microcomputer is forced into the eva-chip mode. The main purpose of this mode is to evaluate ROM programs prior to masking them into the microcomputer's internal ROM.

In this mode, the internal ROM is inhibited so the external memory is requierd.

The lower 8 bits of address data for port P0 is output when ϕ goes to "H" state. When ϕ goes to the "L" state, P0 retains its original I/O functions.

Port P1's higher 8 bits of address data are output when ϕ goes to "H" state and as it changes back to the "L" state it retains its original I/O functions. Port P2 retains its original output functions while ϕ is at the "H" state, and works as a data bus of $D_7 \sim D_0$ (including instruction code) while at the "L" state. Pins P3₁ and P3₀ output the SYNC and R/ \overline{W} control signals, respectively while ϕ is in the "H" state. When in the "L" state, P3₁ and P3₀ retain their original I/O function.

The R/\overline{W} output is used to read/write from/to the outside. When this pin is in the "H" state, the CPU reads data, and when in the "L" state, the CPU writes data.

The SYNC is a synchronous signal which goes to the "H" state when it fetches the OP CODE.

The relationship between the input level of $\mbox{CNV}_{\mbox{SS}}$ and the processor mode is shown in Table 2.



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

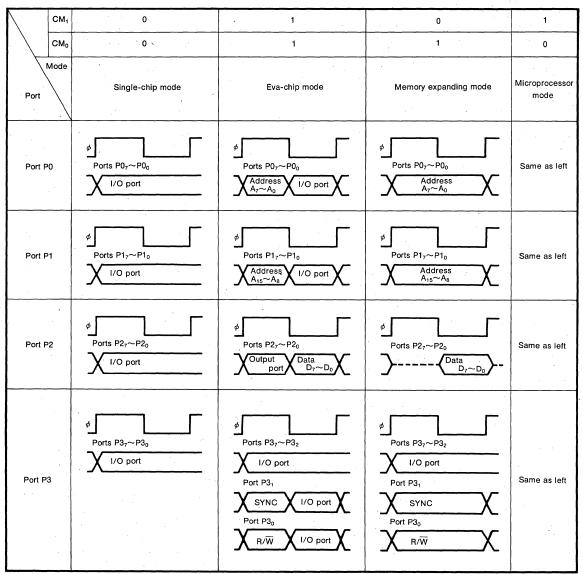


Fig.15 Processor mode and functions of ports P0~P3

Table 2 Relationship between CNV_{SS} pin input level and processor mode

CNVss	Mode	Explanation
V _{ss}	Single-chip mode	The single-chip mode is set by the reset.
	Memory expanding mode	All modes can be selected by changing the processor mode bit with the program.
	Eva-chip mode	
	Microprocessor mode	
V _{CC}	Eva-chip mode	The microprocessor mode is set by the reset.
	Microprocessor mode	Eva-chip mode can be also selected by changing the processor mode bit with the program.
10V	Eva-chip mode	Eva-chip mode only.

CLOCK GENERATING CIRCUIT

The built-in clock generating circuits are shown in Figure 18

When the STP instruction is executed, the oscillation of internal clock ϕ is stopped in the "H" state.

Also, the prescaler X and timer X are loaded with FF_{16} and 01_{16} , respectively. The oscillator (dividing by 16) is then connected to the prescaler input. This connection is cleard when timer X overflows or the reset is in, as discussed in the timer section.

The oscillator is restarted when an interrupt is accepted. However, the internal clock ϕ keeps its "H" level until timer X overflows.

This is because the oscillator needs a set-up period if a ceramic or a quartz crystal oscillator is used.

When the WIT instruction is executed, the internal clock ϕ stops in the "H" level but the oscillator continues running. This wait state is cleared when an interrupt is accepted. Since the oscillation does not stop, the next instructions are executed at once

To return from the stop or the wait status, the interrupt enable bit must be set to "1" before executing STP or WIT instruction. Especially, to return from the stop status, the timer X count stop bit (bit 5 of address $00FF_{16}$) must be set to "0" before executing STP instruction.

The circuit example using a ceramic oscillator (or a quartz crystal oscillator) is shown in Figure 16.

The constant capacitance will differ depending on which oscillator is used, and should be set to the manufactures

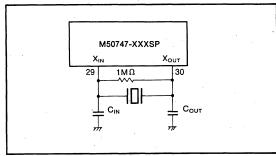


Fig.16 External ceramic resonator circuit

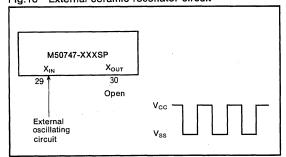


Fig.17 External clock input circuit

suggested value.

The example of external clock uasge is shown in Figure 17. X_{IN} is the input, and X_{OUT} is open.

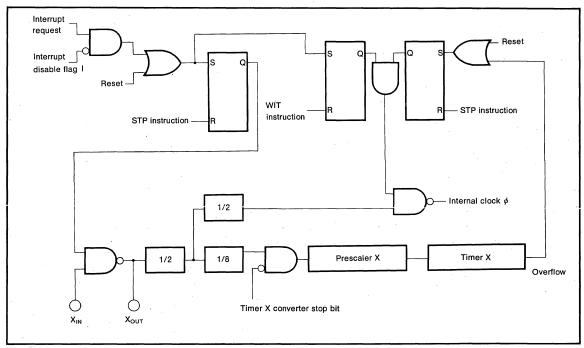


Fig.18 Block diagram of clock generating circuit

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

PROGRAMMING NOTES

- (1) The frequency ratio of the timer and the prescaler is 1/(n+1).
- (2) Even though the BBC and BBS instructions are executed after the interrupt request bits are modified (by the program), those instructions are only valid for the contents before the modification. Also, at least one instruction cycle must be used (such as a NOP) between the modification of the interrupt request bits and the execution of the BBC and BBS instructions.
- (3) Reading the timer and prescaler must be avoided while the input to the prescaler is changing.
- (4) After the ADC and SBC instructions are executed (in decimal mode), one instruction cycle (such as a NOP) is needed before the SEC, CLC, or CLD instructions are executed.
- (5) A NOP instruction must be used after the execution of a PLP instruction.

DATA REQUIRED FOR MASK ORDERING

Please send the following data for mask orders.

- (1) mask ROM confirmation form
- (2) mark specification form
- (3) ROM data ····· EPROM 3sets



MITSUBISHI MICROCOMPUTERS M50747-XXXSP/FP

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Ratings	Unit
Vcc	Supply voltage		-0.3~7	V
Vı	Input voltage, RESET, XIN, INT1, P50~P57		-0.3~7	V
Vı	Input voltage, $P0_0 \sim P0_7$, $P1_0 \sim P1_7$, $P2_0 \sim P2_7$, $P3_0 \sim P3_7$, $P4_0 \sim P4_7$,	With respect to V _{SS} .	-0.3~V _{cc} +0.3	V
Vı	Input voltage, CNV _{SS}	Output transistors cut-off	-0.3~13	V
Vo	Output voltage, $P0_0 \sim P0_7$, $P1_0 \sim P1_7$, $P2_0 \sim P2_7$, $P3_0 \sim P3_7$, $P4_0 \sim P4_7$, $P6_0 \sim P6_7$, X_{OUT} , ϕ		-0.3~V _{cc} +0.3	٧
Pd	Power dissipation	T _a = 25℃	1000(Note 1)	mW
Topr	Operating temperature		-10~70	°C
Tstg	Storage temperature		-40~125	∵ ℃

Note 1: 300mW for QFP types.

RECOMMENDED OPERATING CONDITIONS ($v_{cc} = 5v \pm 10\%$, $\tau_a = -10 \sim 70^{\circ}C$, unless otherwise noted)

Comple at	Dava-salar.		I Imia		
V _{SS} V _{IH} V _{IL} V _{IL} V _{IL} loL(peak)	Parameter	Min.	Nom.	Max.	Unit
V _{CC}	Supply voltage	4.5	5 .	5.5	V
Vss	Supply voltage		0		V
	"H" input voltage, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ ,				
V _{IH}	P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ , P5 ₀ ~P5 ₇ ,	0.8V _{CC}		Vcc	V
	INT ₁ , RESET, X _{IN} , CNV _{SS}				-
	"L" input voltage, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ ,				
	P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ , P5 ₀ ~P5 ₇ ,	0		0.2V _{CC}	V
	INT ₁ , CNV _{SS}				
V _{IL}	"L" input voltage, RESET	0		0.12V _{CC}	V
V _{IL}	"L" input voltage, X _{IN}	0		0.16V _{CC}	٧
	"L" peak output current, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ ,			10	Á
l _{oL(peak)}	P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ , P6 ₀ ~P6 ₇			10	mA
	"L" average output current, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ ,				
I _{OL(avg)}	P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ , P6 ₀ ~P6 ₇			5	mA
	(Note 2)				
	"H" peak output current, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ ,			-10	^
loн(peak)	P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ , P6 ₀ ~P6 ₇			-10	mA
I _{он(avg)}	"H" average output current, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ ,				
	P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ P6 ₀ ~P6 ₇ ,			- 5	mΑ
	(Note 2)				
f _{(XIN})	Internal clock oscillating frequency			8	MHz

Note 2: The average output current I_{OL(avg)} and I_{OH(avg)} are the average value of a period of 100ms

3: Total of I_{OL(peak)}, of ports P0, P1, and P2 is 20mA

Total of I_{OH(peak)}, of ports P0, P1, and P2 is 20mA

Total of I_{IL(peak)}, of ports P3, P4, and P6 is 80mA

Total of I_{OH(peak)}, of ports P3 and P4 is 20mA

Let the total of I_{OH(peak)}, of ports P6 below 60mA

MITSUBISHI MICROCOMPUTERS M50747-XXXSP/FP

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

$\textbf{ELECTRICAL} \quad \textbf{CHARACTERISTICS} \ \, (v_{\text{CC}} = 5\text{V}, \, v_{\text{SS}} = 0\text{V}, \, \tau_{a} = 25\text{°C}, \, f_{(X_{\text{IN}})} = 8\text{MHz}, \, \text{unless otherwise noted})$

0	Devenuetos	Test conditions					
Symbol	Parameter	Test co	rest conditions		Тур.	Max.	Unit
V _{OH}	"H" output voltage, $P0_0 \sim P0_7$, $P1_0 \sim P1_7$, $P2_0 \sim P2_7$, $P3_0 \sim P3_7$, $P4_0 \sim P4_7$, $P6_0 \sim P6_7$	I _{OH} = -10mA		3			V
V _{OH}	"H" output voltage, ϕ ,	$I_{OH} = -2.5 \text{mA}$		3			V
V _{OL}	"L" output voltage, $P0_0 \sim P0_7$, $P1_0 \sim P1_7$, $P2_0 \sim P2_7$, $P3_0 \sim P3_7$, $P4_0 \sim P4_7$, $P6_0 \sim P6_7$	I _{OL} = 10mA				2	V
VoL	"L" output voltage, φ	$I_{OL} = 5mA$				`2	V
$V_{T+}-V_{T-}$	Hysteresis, P3 ₆	When used as CLK in	nput	0.3		1	V
$V_{T+}-V_{T-}$	Hysteresis, INT ₁			0.3		1	V
$V_{T+}-V_{T-}$	Hysteresis, P32	When used as INT ₂ p	oin	0.3		1	٧
V _{T+} -V _{T-}	Hysteresis, P3 ₃	When used as CNTR	input	0.3		1	٧
V _{T+} V _{T-}	Hysteresis, RESET				0.5	0.7	V
$V_{T+}-V_{T-}$	Hysteresis, X _{IN}			0.1		0.5	V
I _{IL}	"L" input current, $P0_0 \sim P0_7$, $P1_0 \sim P1_7$, $P2_0 \sim P2_7$, $P3_0 \sim P3_7$, $P4_0 \sim P4_7$, $P5_0 \sim P5_7$, $P6_0 \sim P6_7$, \overline{INT}_1 , \overline{RESET} , X_{IN}	V _i = 0V			,	5	μΑ
Ін	"H" input current, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ , P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ , P5 ₀ ~P5 ₇ , P6 ₀ ~P6 ₇ , ĪNT ₁ , RESET, X _{IN}	V _I = 5V				5	μА
V _{RAM}	RAM retention voltage	At stop mode		2			٧
			f _(XIN) = 8MHz Square wave		6	12	mA
Icc	Supply current	Output terminals are opened,	At stop mode Ta = 25°C		,	1	μA
	. :	others to V _{SS}	At stop mode T _a = 70℃			10	μА



MITSUBISHI MICROCOMPUTERS M50747-XXXSP/FP

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

TIMING REQUIREMENTS Single-chip mode ($V_{CC} = 5V \pm 10\%$, $V_{SS} = 0V$, $T_a = 25^{\circ}C$, $f_{(X_{IN})} = 8MHz$, unless otherwise noted)

Symbol	Parameter		Limits		Unit
Symbol	Farantetei .	Min.	Тур.	Max.	Unit
t _{su (POD-ø)}	Port P0 input setup time	200			ns
t _{SU (P1D-ø)}	Port P1 input setup time	200			ns
tsu (P2D-ø)	Port P2 input setup time	200			ns
t _{su (P3D-¢)}	Port P3 input setup time	200			ns
t _{SU (P4D-¢)}	Port P4 input setup time	200			ns
t _{SU (P5D-¢)}	Port P5 input setup time	200			ns
t _{h (φ-P0D)}	Port P0 input hold time	20			ns
th (φ-P1D)	Port P1 input hold time	20			ns
t _{h (φ-P2D)}	Port P2 input hold time	20			ns
t _{h (ø-P3D)}	Port P3 input hold time	20			ns
t _{h (φ-P4D)}	Port P4 input hold time	20			ns
th (_P5D)	Port P5 input hold time	20			ns
t _C	External clock input cycle time	125			ns
t _W	External clock input pulse width	62			ns
t _r	External clock rising edge time			20	ns
tf	External clock falling edge time			20	ns

Eva-chip mode and microprocessor mode

(V_{CC} = 5V \pm 10%, V_{SS} = 0V, T_a = 25°C, f_(X_{IN}) = 8MHz, unless otherwise noted)

Completed	Parameter		Limits		
		Min.	Тур.	Max.	Unit
t _{SU} (POD-¢)	Port P0 input setup time	200			ns
t _{SU (P1D-ø)}	Port P1 input setup time	200			ns
tsu (P2D-ø)	Port P2 input setup time	150			ns
th (ø-POD)	Port P0 input hold time	20			ns
th (#-P1D)	Port P1 input hold time	20			ns
th (¢-P2D)	Port P2 input hold time	20			ns

Memory expanding mode and microprocessor mode

 $(V_{CC} = 5V \pm 10\%, V_{SS} = 0V, T_a = 25\%, f_{(X_{IN})} = 8MHz, unless otherwise noted)$

Complement			1.1-14		
Symbol	Parameter	Min.	Тур.	Max.	Unit
t _{su (P2D-ø)}	Port P2 input setup time	150			ns
th (ø-P2D)	Port P2 input hold time	20			ns

SWITCHING CHARACTERISTICS

 $\textbf{Single-chip} \quad \textbf{mode} \ \, (v_{cc} = 5V \pm 10\%, \ \, v_{ss} = 0V, \ \, T_{a} = 25^{\circ}C, \ \, f_{(X_{IN})} = 8MHz, \ \, unless \ \, otherwise \ \, noted)$

	B	Took oon distant		Unit		
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
td(≠-POQ)	Port P0 data output delay time				200	ns
td(ø-P1Q)	Port P1 data output delay time				200	ns
td(ø-P2Q)	Port P2 data output delay time] =:- 10			200	ns
td(ø-P3Q)	Port P3 data output delay time	Fig.19			200	ns
td(ø-P4Q)	Port P4 data output delay time				200	ns
td(ø-P6Q)	Port P6 data output delay time	·			200	ns

Eva-chip mode ($V_{cc} = 5V \pm 10\%$, $V_{ss} = 0V$, $T_a = 25\%$, $f_{(X_{|N})} = 8MHz$, unless otherwise noted)

Comple at	Parameter	Test conditions		Unit		
Symbol		rest conditions	Min.	Тур.	Max.	Oill
td(ø-POA)	Port P0 address output delay time				150	ns
td(ø-POAF)	Port P0 address output delay time				150	ns
td(ø-POQ)	Port P0 data output delay time	1			200	ns
td(ø-POQF)	Port P0 data output delay time				150	ns
td(ø-P1A)	Port P1 address output delay time	1			150	ns
td(ø-PIAF)	Port P1 address output delay time -	7			150	ns
td(ø-P1Q)	Port P1 data output delay time	1			200	ns
td(ø-P1QF)	Port P1 data output delay time	1			150	ns
td(ø-P2Q)	Port P2 data output delay time	F:= 10			200	ns
td(ø-P2QF)	Port P2 data output delay time	Fig.19			150	ns
td(ø-R/W)	R/W signal output delay time	1			150	ns
td(ø-R/WF)	R/W signal output delay time	1			150	ns
td(ø-P30Q)	Port P3₀ data output delay time	7			200	ns
td(ø-P30QF)	Port P3 ₀ data output delay time				150	ns
td(ø-sync)	SYNC signal output delay time				150	ns
td(ø-synce)	SYNC signal output delay time	1			150	ns
t _{d(ø-P310)}	Port P3 ₁ data output delay time				200	ns
td(ø-P31QF)	Port P3 ₁ data output delay time				150	ns

Memory expanding mode and microprocessor mode

 $(\text{V}_{\text{CC}} = 5\text{V} \pm 10\%, \text{ V}_{\text{SS}} = 0\text{V}, \text{ T}_{\text{A}} = 25^{\circ}\text{C}, \text{ f}_{(\text{X}_{\text{IN}})} = 8\text{MHz}, \text{ unless otherwise noted})$

Cumbal	Parameter	Took oondiking		Limits			
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
td(ø-POA)	Port P0 address output delay time				150	ns	
td(# -P1A)	Port P1 address output delay time				150	ns	
td(\$ -P2Q)	Port P2 data output delay time	F:-10			200	ns	
t _{d(ø-P2QF)}	Port P2 data output delay time	Fig.19	30		150	ns	
t _{d(ø-R/W)}	R/W signal output delay time				150	ns	
td(ø-sync)	SYNC signal output delay time				150	ns	

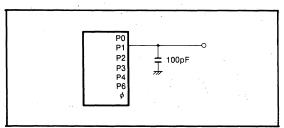
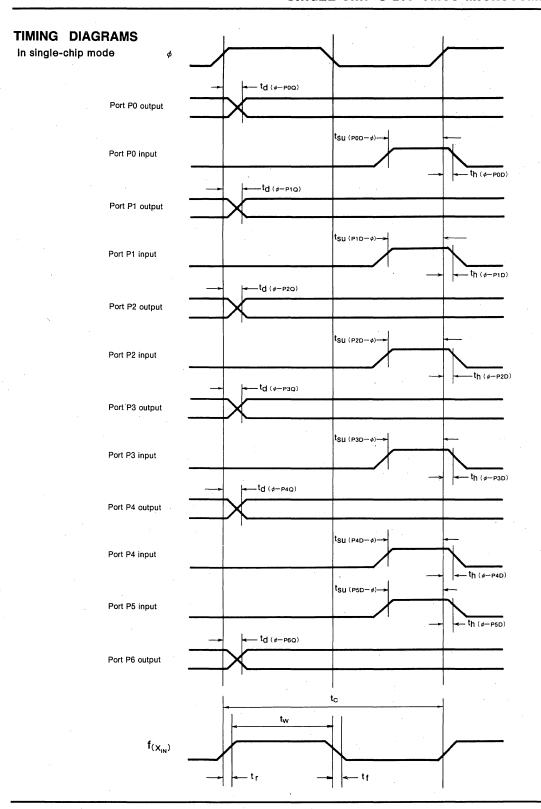
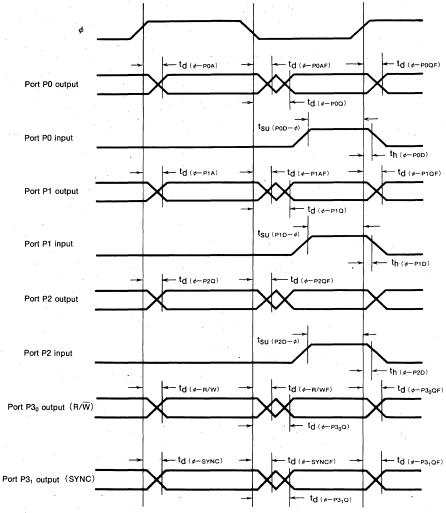


Fig.19 Ports P0~P4 and port P6 test circuit





In eva-chip mode



Port P0 output

Port P1 output

Port P2 output

Port P2 input

Port P3, output (SYNC)

Port P3, output (SYNC)

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

DESCRIPTION

The M50747H-XXXSP is a single-chip microcomputer designed with CMOS silicon gate technology. It is housed in a 64-pin shrink plastic molded DIP (flat package type also available). This single-chip microcomputer is useful for business equipment and other consumer applications.

In addition to its simple instruction sets, the ROM, RAM, and I/O addresses are placed on the same memory map to enable easy programming.

In this section, the following explanations apply to the differences between the M50747-XXXSP and the M50747H-XXXSP. Other functions are explained in the M50747-XXXSP's section in detail.

Type name	Maximum value of clock generating frequency
M50747-XXXSP	8MHz
M50747H-XXXSP	12MHz

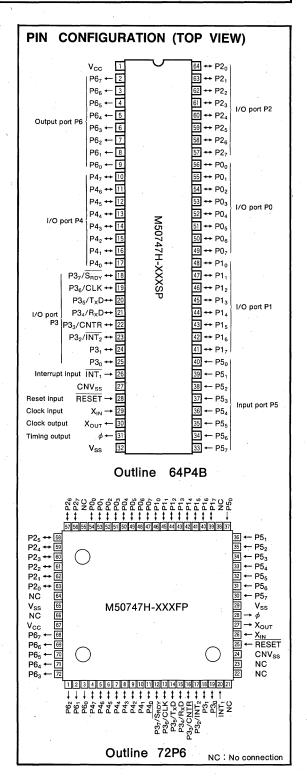
The differences between the M50747H-XXXSP and the M50747H-XXXFP are the package outline and power dissipation ability (absolute maximum ratings).

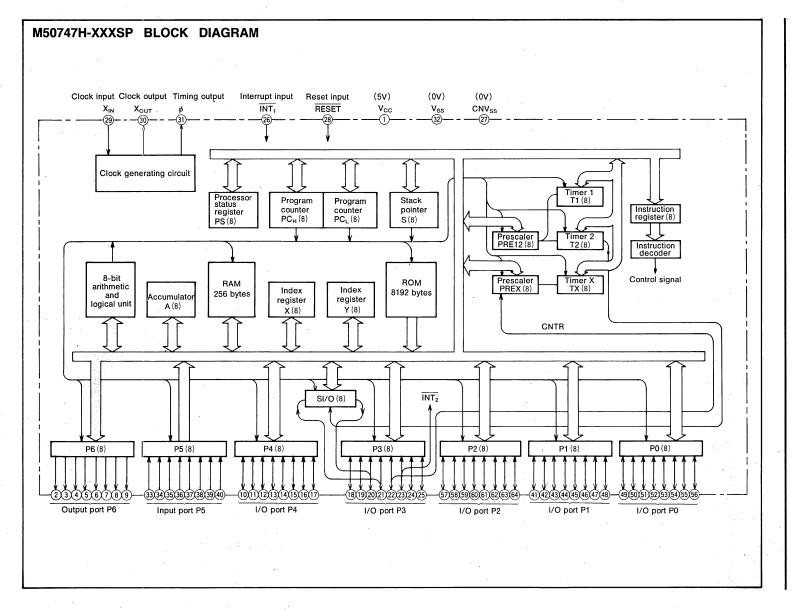
DISTINCTIVE FEATURES

•	Number of basic instructions 69
•	Memory size ROM ······ 8192 bytes
	RAM 256 bytes
•	Instruction execution time
	0.66µs (minimum instructions at 12MHz frequency)
•	Single power supply $f(X_{IN})=12MHz\cdots 5V\pm 5\%$
•	Power dissipation
	normal operation mode (at 12MHz frequency) 45mW
•	Subroutine nesting ·······128 levels (Max.)
•	Interrupt ······7 types, 5 vecters
•	8-bit timer ······3 (2 when used as serial I/O)
•	Programmable I/O (Ports P0, P1, P2, P3, P4) ········ 40
•	Input ports (Port P5)8
•	Output ports (Port P6)8
•	Serial I/O (Clock synchronized or UART)1

APPLICATION

Office automation equipment VCR, Tuner, Audio-visual equipment





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

MITSUBISHI MICROCOMPUTERS

M50747H-XXXSP/FP

MITSUBISHI MICROCOMPUTERS M50747H-XXXSP/FP

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

FUNCTIONS OF M50747H-XXXSP

	Parameter		Functions		
Number of basic instructions			69		
Instruction execution time			0.66µs (minimum instructions, at 12MHz of frequency)		
Clock frequency			12MHz		
ROM			8192bytes		
Memory size	RAM		256bytes		
	INT ₁	Input	1-bit×1		
	DO D4 D0 D0 D4	1/0	8-bit×5 (Part of P3 are in common with Input/output of serial I/O,		
Input/output port	P0, P1, P2, P3, P4	1/0	timer I/O and INT ₂ interrupt input)		
•	P5	Input	8-bit×1		
	P6	Output	8-bit×1		
Serial I/O			8-bit or 9-bit×1		
Timers			8-bit prescaler×2+8-bit timer×3 (8-bit timer×2 when serial I/O is used)		
Subroutine nesting			128levels (max.)		
			Two external interrupts (1 of external interrupt is in common with port P3 ₂)		
Interrupts	•		Three timer interrupts (or timer×2, serial I/O×1)		
Clock generating circuit		-	Built-in (Ceramic or Quartz crystal oscillator)		
Supply voltage			5V±5%		
Power dissipation	at high-speed operation		45mW (at 12MHz frenquency)		
	Input/output voltage		5V		
Input/output characteristics	t characteristics Output current		10mA (Ports P3, P4, P6)		
Memory expansion			Possible		
Operating temperature range			-10~70℃		
Device structure			CMOS silicon gate		
D!	M50747H-XXXSP		64-pin shrink plastic molded DIP		
Package	M50747H-XXXFP		72-pin plastic molded QFP		

MITSUBISHI MICROCOMPUTERS M50747H-XXXSP/FP

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

PIN DESCRIPTION

Pin	Name	Input/ Output	Functions
V _{cc} V _{ss}	Supply voltage		Power supply inputs 5V±5% to V _{CC} , and 0V to V _{SS} .
CNV _{ss}	CNV _{SS}		This is usually connected to V _{SS} .
RESET	Reset input	Input	To enter the reset state, the reset input pin must be kept at a "L" for more than $2\mu s$ (under normal V_{CC} conditions). If more time is needed for the crystal oscillator to stabilize, this "L" condition should be maintained for the required time.
X _{IN}	Clock input	Input	This chip has an internal clock generating circuit. To control generating frequency, an external ceramic or a quartz crystal oscillator is connected between the X _{IN} and X _{OUT} pins. If an external clock is used, the clock
Хоит	Clock output	Output	quartz crystal oscillator is collifected between the X_{IN} and X_{OUT} pins. If an external clock is used, the clock source should be connected the X_{IN} pin and the X_{OUT} pin should be left open.
φ	Timing output	Output	This is the timing output pin.
ĪNT ₁	Interrupt input	Input	This is the highest order interrupt input pin.
P0 ₀ ~P0 ₇	I/O port P0	1/0	Port P0 is an 8-bit I/O port with directional registers allowing each I/O bit to be individually programmed as input or output. At reset, this port is set to input mode. The output structure is CMOS output.
P1 ₀ ~P1 ₇	I/O port P1	1/0 .	Port P1 is an 8-bit I/O port and has basically the same functions as port P0.
P2 ₀ ~P2 ₇	I/O port P2	1/0	Port P2 is an 8-bit I/O port and has basically the same functions as port P0.
P3 ₀ ~P3 ₇	I/O port P3	1/0	Port P3 is an 8-bit I/O port and has basically the same functions as port P0. When serial I/O is used, P3 ₆ , P3 ₅ , and P3 ₄ work as CLK, T_XD pins, respectively. When clock synchronous serial I/O is used, P3 ₇ works as $\overline{S_{RDY}}$. Also P3 ₃ and P3 ₂ work as CNTR pin and the lowest order interrupt input pin $(\overline{INT_2})$, respectively.
P4 ₀ ~P4 ₇	I/O port P4	1/0	Port P4 is an 8-bit I/O port and has basically the same functions as port P0.
P5 ₀ ~P5 ₇	Input port P5	Input	Port P5 is an 8-bit input port.
P6 ₀ ~P6 ₇	Output port P6	Output	Port P6 is an 8-bit output port. The output structure is CMOS output.

MITSUBISHI MICROCOMPUTERS M50747H-XXXSP/FP

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Ratings	Unit
V _{CC}	Supply voltage		−0.3~7	٧
Vı	Input voltage, RESET, X _{IN} , INT ₁ , P5 ₀ ~P5 ₇		−0.3~7	V
Vı	Input voltage, $P0_0 \sim P0_7$, $P1_0 \sim P1_7$, $P2_0 \sim P2_7$, $P3_0 \sim P3_7$, $P4_0 \sim P4_7$,	With respect to V _{SS} .	-0.3~V _{cc} +0.3	V
Vı	Input voltage, CNV _{SS}	Output transistors cut-off	-0.3~13	V
Vo	Output voltage, $P0_0 \sim P0_7$, $P1_0 \sim P1_7$, $P2_0 \sim P2_7$, $P3_0 \sim P3_7$, $P4_0 \sim P4_7$, $P6_0 \sim P6_7$, X_{OUT} , ϕ		-0.3~V _{cc} +0.3	V
Pd	Power dissipation	T _a = 25℃	1000(Note 1)	mW
Topr	Operating temperature	1	-10~70	°C
Tstg	Storage temperature		−40~125	°C

Note 1: 300mW for QFP types.

RECOMMENDED OPERATING CONDITIONS ($V_{CC} = 5V \pm 5\%$, $T_a = -10 \sim 70^{\circ}C$, unless otherwise noted)

Symbol	Parameter		11-14			
Syllibol	Farameter		Nom.	Max.	Unit	
Vcc	Supply voltage	4. 75	5	5. 25	٧	
V _{SS}	Supply voltage		0		V	
	"H" input voltage, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ ,					
V _{IH}	P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ , P5 ₀ ~P5 ₇ ,	0.8V _{CC}		Vcc	· V	
	INT1, RESET, XIN, CNVSS					
	"L" input voltage, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ ,					
V _{IL}	$P3_0 \sim P3_7$, $P4_0 \sim P4_7$, $P5_0 \sim P5_7$,	0		0.2V _{CC}	V	
	INT ₁ , CNV _{SS}					
V _{IL}	"L" input voltage, RESET	0		0.12V _{CC}	V	
V _{IL}	"L" input voltage, X _{IN}	0		0.16V _{CC}	V	
	"L" peak output current, P00~P07, P10~P17, P20~P27,			10		
loL(peak)	P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ , P6 ₀ ~P6 ₇			10	mA	
	"L" average output current, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ ,					
I _{OL(avg)}	P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ , P6 ₀ ~P6 ₇			5	. mA	
_	(Note 2)					
	"H" peak output current, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ ,			10		
loн(peak)	P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ , P6 ₀ ~P6 ₇			-10	mA	
I _{он(avg)}	"H" average output current, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ ,					
	P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ P6 ₀ ~P6 ₇ ,			- 5	mA	
	(Note 2)					
f _(XIN)	Internal clock oscillating frequency			12	MHz	

Note 2: The average output current I_{OL(avg)} and I_{OH(avg)} are the average value of a period of 100ms

3: Total of I_{OL(peak)}, of ports P0, P1, and P2 is 20mA
 Total of I_{OH(peak)}, of ports P3, P4, and P6 is 80mA
 Total of I_{OH(peak)}, of ports P3 and P4 is 20mA
 Let the total of I_{OH(peak)}, of ports P6 below 60mA



MITSUBISHI MICROCOMPUTERS M50747H-XXXSP/FP

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

$\textbf{ELECTRICAL} \quad \textbf{CHARACTERISTICS} \; (v_{cc} = 5\text{V}, \, v_{ss} = 0\text{V}, \, T_a = 25\text{°C}, \, f_{(x_{\text{IN}})} = 12\text{MHz}, \, \text{unless otherwise noted})$

O	Parameter	Test conditions		Limits			14-24
Symbol				Min.	Тур.	Max.	Unit
V _{OH}	"H" output voltage, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ , P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ , P6 ₀ ~P6 ₇	I _{ОН} = -10mA		3			٧
V _{OH}	"H" output voltage, ϕ ,	$I_{OH} = -2.5 mA$		3			٧
V _{OL}	"L" output voltage, $P0_0 \sim P0_7$, $P1_0 \sim P1_7$, $P2_0 \sim P2_7$, $P3_0 \sim P3_7$, $P4_0 \sim P4_7$, $P6_0 \sim P6_7$	I _{OL} = 10mA				2	V
VoL	"L" output voltage, ϕ	I _{OL} = 5mA				2	٧
$V_{T+}-V_{T-}$	Hysteresis, P3 ₆	When used as CLK	input	0.3		1	V
V _{T+} -V _{T-}	Hysteresis, INT ₁			0.3		1	V
V _{T+} -V _{T-}	Hysteresis, P3 ₂	When used as INT ₂	pin .	0.3		1	V
$V_{T+}-V_{T-}$	Hysteresis, P3 ₃	When used as CNTF	When used as CNTR input			. 1	1. V
$V_{T+}-V_{T-}$	Hysteresis, RESET				0.5	0.7	V
$V_{T+}-V_{T-}$	Hysteresis, X _{IN}					0.5	V
l₁∟	"L" input current, $P0_0 \sim P0_7$, $P1_0 \sim P1_7$, $P2_0 \sim P2_7$, $P3_0 \sim P3_7$, $P4_0 \sim P4_7$, $P5_0 \sim P5_7$, $P6_0 \sim P6_7$, $\overline{INT_1}$, \overline{RESET} , X_{IN}	$V_1 = 0V$	V ₁ = 0V			-5	μA
l _{IH}	"H" input current, P0 ₀ ~P0 ₇ , P1 ₀ ~P1 ₇ , P2 ₀ ~P2 ₇ , P3 ₀ ~P3 ₇ , P4 ₀ ~P4 ₇ , P5 ₀ ~P5 ₇ , P6 ₀ ~P6 ₇ , INT, RESET, X _{IN}	V ₁ = 5V	V ₁ = 5V			5	. μΑ
V _{RAM}	RAM retention voltage	At stop mode		2			V
			f _(XIN) = 12MHz Square wave		9	18	mA
Icc	Supply current	Output terminals are opened,	At stop mode $T_a = 25^{\circ}C$			1	μΑ
		others to V_{SS} At stop mode $T_a = 70^{\circ}C$				10	μА

TIMING REQUIREMENTS

Single-chip mode $(V_{CC} = 5V \pm 5\%, V_{SS} = 0V, T_a = 25^{\circ}C, f_{(x_{IN})} = 12MHz, unless otherwise noted)$

Cumbal	Parameter		Limit		
Symbol	Parameter		Тур.	Max.	Unit
t _{su (POD-ø)}	Port P0 input setup time	100			ns
t _{su (P1D-ø)}	Port P1 input setup time	100			ns
t _{su (P2D-ø)}	Port P2 input setup time	100			ns
t _{su (P3D-ø)}	Port P3 input setup time	100			ns
t _{SU (P4D-ø)}	Port P4 input setup time	100			ns
t _{su (P5D-ø)}	Port P5 input setup time	100			ns,
t _{h (φ-P0D)}	Port P0 input hold time	20			ns
th (ø-P1D)	Port P1 input hold time	20			ns
th (ø-P2D)	Port P2 input hold time	20			ns
t _{h (ø-P3D)}	Port P3 input hold time	20			ns
th (ø-P4D)	Port P4 input hold time	. 20			ns
t _{h (φ-P5D)}	Port P5 input hold time	20			ns
t _C	External clock input cycle time	83			ns
t _w	External clock input pulse width	41			ns
tr	External clock rising edge time		*	20	ns
tf	External clock falling edge time			20	ns

Eva-chip mode and microprocessor mode

 $(V_{CC} = 5V \pm 5\%, V_{SS} = 0V, T_a = 25$ °C, $f_{(X_{IN})} = 12$ MHz, unless otherwise noted)

Symbol	Parameter	·	Limits			
		Min.	Тур.	Max.	Unit	
t _{su (POD-ø)}	Port P0 input setup time	100			ns	
t _{SU (P1D-ø)}	Port P1 input setup time	100			ns	
t _{SU (P2D-ø)}	Port P2 input setup time	. 75			ns	
th (ø-POD)	Port P0 input hold time	20			ns	
th (ø-P1D)	Port P1 input hold time	20			ns	
th (ø-P2D)	Port P2 input hold time	. 20			ns	

Memory expanding mode and microprocessor mode

 $(V_{CC} = 5V \pm 5\%, V_{SS} = 0V, T_a = 25^{\circ}C, f_{(X_{IN})} = 12MHz, unless otherwise noted)$

Symbol	Parameter		11-14				
Cymbo.			Min.	Тур.	Max.	Unit	
t _{su (P2D-ø)}	Port P2 input setup time			75			ns
th (ø-P2D)	Port P2 input hold time			20			ns

 $\begin{array}{ll} \textbf{SWITCHING} & \textbf{CHARACTERISTICS} \\ \textbf{Single-chip} & \textbf{mode} \ (V_{CC} = 5V \pm 5\%, \ V_{SS} = 0V, \ T_{a} = 25 \, ^{\circ}\text{C}, \ f_{(x_{\text{IN}})} = 12 \text{MHz, unless otherwise noted}) \end{array}$

Symbol	Parameter	Tank and distance	Limits			1111
		Test conditions	Min.	Тур.	Max.	Unit
td(≠P0Q)	Port P0 data output delay time				150	ns
td(4-P1Q)	Port P1 data output delay time				150	ns
td(ø-P2Q)	Port P2 data output delay time				150	ns
td(ø-P3Q)	Port P3 data output delay time	Fig. 1			150	ns
t _{d(∳-P4Q)}	Port P4 data output delay time				150	ns
td(ø-P6Q)	Port P6 data output delay time				150	ns

Eva-chip mode ($V_{CC} = 5V \pm 5\%$, $V_{SS} = 0V$, $T_a = 25^{\circ}C$, $f_{(X_{IN})} = 12MHz$, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			
			Min.	Тур.	Max.	Unit
td(ø-POA)	Port P0 address output delay time	Fig. 1			140	ns
td(ø-POAF)	Port P0 address output delay time				140	ns
td(ø-POQ)	Port P0 data output delay time				150	ns
td(ø-POQF)	Port P0 data output delay time				140	ns
td(ø-PIA)	Port P1 address output delay time .				140	ns
td(ø-P1AF)	Port P1 address output delay time				140	ns
t _{d(ø-P1Q)}	Port P1 data output delay time				150	ns
td(ø-P1QF)	Port P1 data output delay time				140	ns
td(ø-P2Q)	Port P2 data output delay time				150	ns
td(ø-P2QF)	Port P2 data output delay time				140	ns
t _{d(ø-R/W)}	R/W signal output delay time			,	140	ns
td(ø-R/WF)	R/W signal output delay time				140	ns
t _{d(φ-P3₀Q)}	Port P3 ₀ data output delay time				150	ns
td(ø-P30QF)	Port P3 ₀ data output delay time				140	ns
td(ø-sync)	SYNC signal output delay time				140	ns
td(ø-SYNCF)	SYNC signal output delay time				140	ns
td(ø-P31Q)	Port P3 ₁ data output delay time				150	ns
td(\$-P31QF)	Port P3 ₁ data output delay time				140	ns

Memory expanding mode and microprocessor mode

 $(\rm V_{CC}=5\rm V\pm5\%,~\rm V_{SS}=0\rm V,~\rm T_{a}=25\rm ^{\circ}C,~\rm f_{(\rm X_{IN})}=12\rm MHz,~unless~otherwise~noted)$

Symbol	Parameter	Took one distance	Limits			11-11
		Test conditions	Min.	Тур.	Max.	Unit
td(ø-P0A)	Port P0 address output delay time				140	ns
td(ø -P1A)	Port P1 address output delay time				140	· ns
td(+-P2Q)	Port P2 data output delay time				. 155	ns
td(ø-P2QF)	Port P2 data output delay time	Fig. 1	40		140	ns
t _{d(φ-R/W)}	R/W signal output delay time				140	ns
td(+-SYNC)	SYNC signal output delay time				140	ns

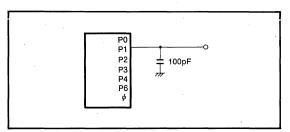


Fig.1 Ports P0~P4 and port P6 test circuit

TIMING DIAGRAMS In single-chip mode - td (ø-P0Q) Port P0 output tsu (POD-#)-Port P0 input - th (ø-POD) Port P1 output tsu (P1D-ø)--Port P1 input _td (ø—p2Q) Port P2 output t_{su (P2D-ø)-} Port P2 input -th (ø−P2D) _td (ø—₽3Q) Port P3 output t_{su (P3D-ø)-} Port P3 input — th (ф—рзD) td (ø-P4Q) Port P4 output t_{SU (P4D-ø)-} Port P4 input tsu (P5D-ø)-Port P5 input Port P6 output t_{C} $t_{\text{W}} \\$ $f_{(\boldsymbol{X}_{IN})}$

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In eva-chip mode

